

## ightarrow ightarrow ightarrow Inductors (Coils) ightarrow Detailed Information

## Inductors (Coils)

Product Top Pa	ge Search by Part No.	Search by Characteristics	Cross Reference	Catalog	Tech Notes	▼ more
MHQ04	02P1N6CT	000				Image: State of the state o
Applications	Commercial Gra	de				PDF file of this page
Feature	Multilayer   Multilayer     Non-Mag Core   Non-Magnetic Core (Dielectric Ceramic)     Super High Q   Super High Q			о • • • • • • • • •		Contact
Series   Type	ries   Type MHQ-P					Documents
Status	Production (Not Recommended for New Design) Recommended Alternate Part No. : <u>MHQ0402PSA1N6CT000</u> (Interc hangeability is not guaranteed.)		and	Images are for reference only and show exemplary products.	Catalog Catalog RoHS Certificate SVHC/REACH Certificate	
Brand	TDK					Product Lineup
						[Selection Guide] Inductors for high frequency applications Update
Size						Sample Kits
Length(L)		0.44mm ±0.0	2mm			Technical Support Tools
Width(W)			0.24mm ±0.02mm			S-parameter
Thickness   Hei	aht	0.24mm ±0.0				SPICE Netlist (Simple)
•	Land Pattern (A)		0.15mm to 0.20mm			SPICE Netlist (Precision)
Recommended Land Pattern (B)		0.20mm Non				Equivalent Circuit Model
Recommended Land Pattern (C)		0.18mm to 0	0.18mm to 0.20mm			
Electrical Char	racteristics					
Inductance		1.6nH ±0.2nl	1.6nH ±0.2nH at 500MHz			
Rated Current		320mA	320mA			
DC Resistance [Typ.]		140mΩ				
DC Resistance	[Max.]	300mΩ				
Self Resonant Frequency [Min.]		8GHz	8GHz			
Self Resonant Frequency [Typ.]		11.1GHz	11.1GHz			
Q [Min.]		10 at 500MH	10 at 500MHz			
Q [Тур.]		14 at 500MH	14 at 500MHz			
Other						
Operating Temp	o. Range (Including Self-T	emp. Rise) -55 to 125°C				
Soldering Method Reflow						
AEC-Q200 No						
Packing Punched (Paper)Taping [180		per)Taping [180mm	Reel]			
Package Quantity 20000pcs						
-	Weight 0.00011g					

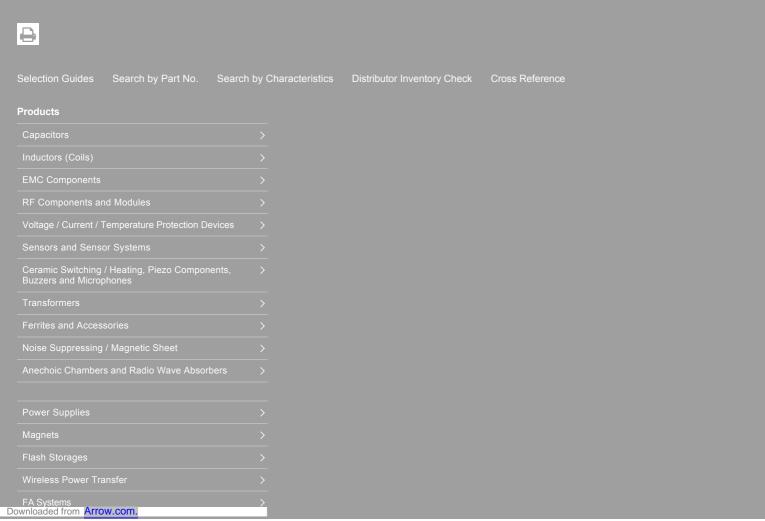
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characteristics.)

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Change settings	Change settings
Inductance	Q
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Transparent Conductive Film	>	
Micro Modules (Substrates with Built-in ICs, Products Utilizing with SESUB)		
Solar Cells		
Biosensor		
Application Specific IC (ASIC) Development and Supply		
Application Guides		
Technical Support		
Tech Library		
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